

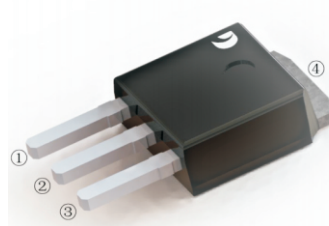


Surface Mount Ultra fast Recovery Rectifier  
Reverse Voltage – 100 to 1000 V  
Forward Current – 3.0 A

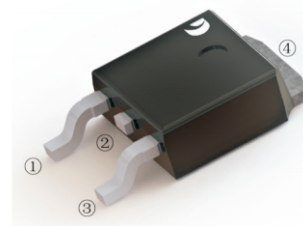
**FEATURES**

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any

**TO-251(I-PAK)**



**TO-252(D-PAK)**



**MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS**

Ratings at 25°C ambient temperature unless otherwise specified

CHARACTERISTICS	TO-251	US301VS	US302VS	US304VS	US306VS	US308VS	US310VS	Units
	TO-252	US301DS	US302DS	US304DS	US306DS	US308DS	US310DS	
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	3.0						A
Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	$I_{FSM}$	90						A
Max Instantaneous Forward Voltage at 3 A DC	$V_F$	1.0		1.30		1.70		V
Maximum DC Reverse Current $T_a = 25^\circ\text{C}$ at Rated DC Reverse Voltage $T_a = 125^\circ\text{C}$	$I_R$	1 300						uA
Typical Junction Capacitance $f = 1\text{MHz}, 4\text{V DC}$	$C_j$	45						pF
Typical Thermal Resistance <sup>(1)</sup>	$R_{\theta JC}$	25						°C/W
Maximum Reverse Recovery Time <sup>(2)</sup>	$t_{rr}$	50			75			ns
Operating Junction Temperature Range	$T_j$	-55 ~ +150						°C
Storage Temperature Range	$T_{stg}$	-55 ~ +150						°C

( 1 ) P.C.B. mounted with 10cm x 10cm x 1mm copper pad areas.

( 2 ) Measured with  $I_F = 0.5\text{ A}$ ,  $I_R = 1\text{ A}$ ,  $I_{rr} = 0.25\text{ A}$ .



Fig.1 Maximum Average Forward Current Rating

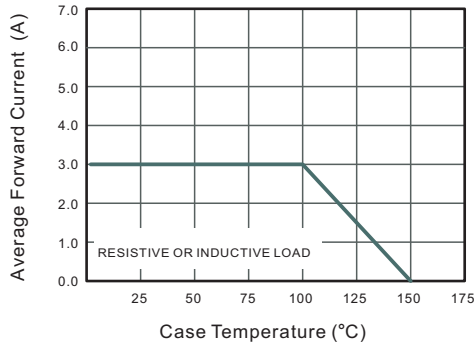


Fig.2 Typical Reverse Characteristics

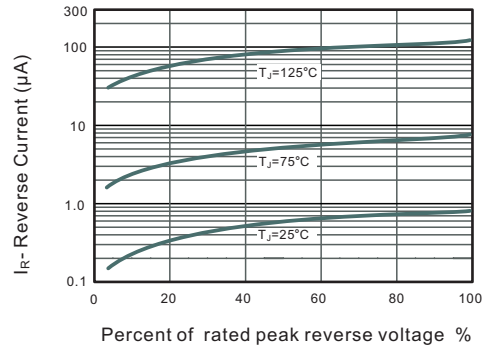


Fig.4 Typical Forward Characteristics

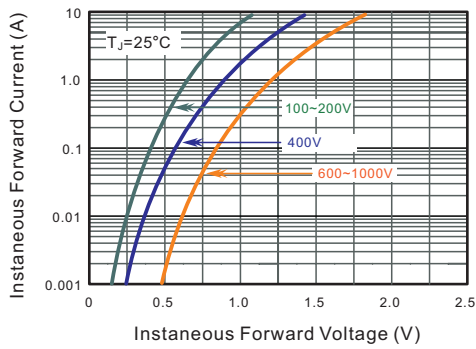


Fig.4 Typical Junction Capacitance

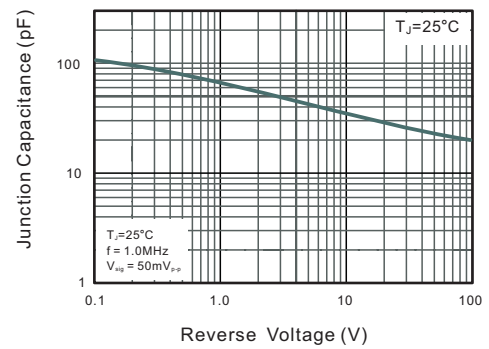
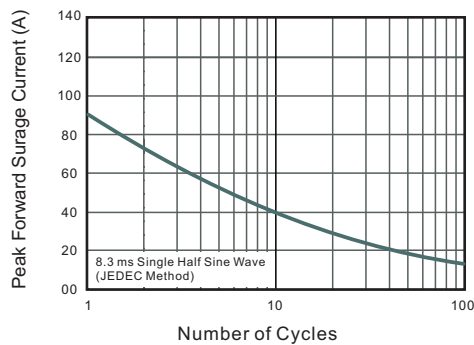
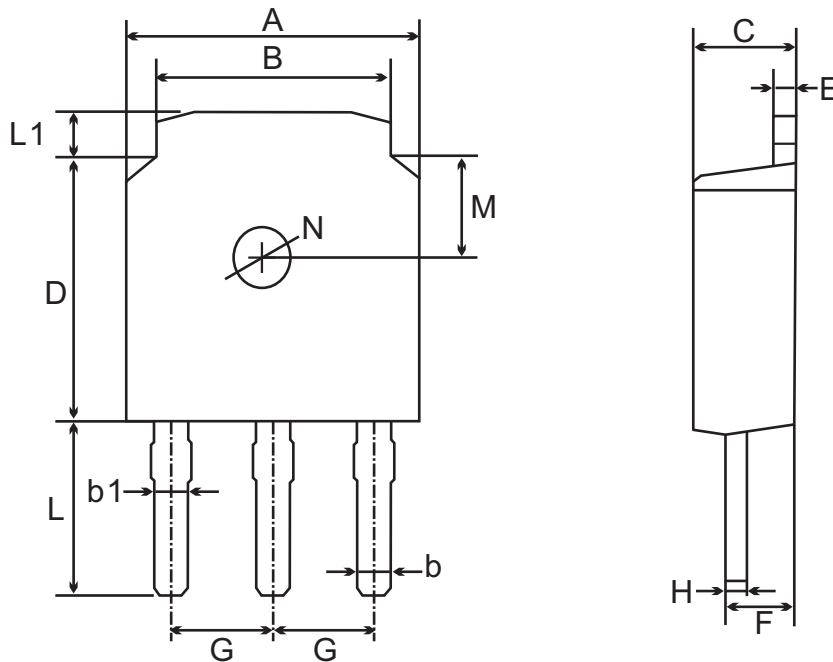


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current





TO-251(D-PAK) Package Outline Dimensions



TO-251(I-PAK) mechanical data

UNIT		A	B	b	b1	C	D	E	F	G	H	L	L1	M	N
mm	max	6.7	5.5	0.8	0.9	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	4.3	1.2	1.8 TYPICAL	1.3 TYPICAL
	min	6.3	5.1	0.3	0.76	2.1	5.9	0.4	1.3		0.45	3.9	0.8		
mil	max	264	217	31	35	98	248	24	71	90 TYPICAL	22	169	47	71 TYPICAL	51 TYPICAL
	min	248	201	12	30	83	232	16	51		18	154	31		

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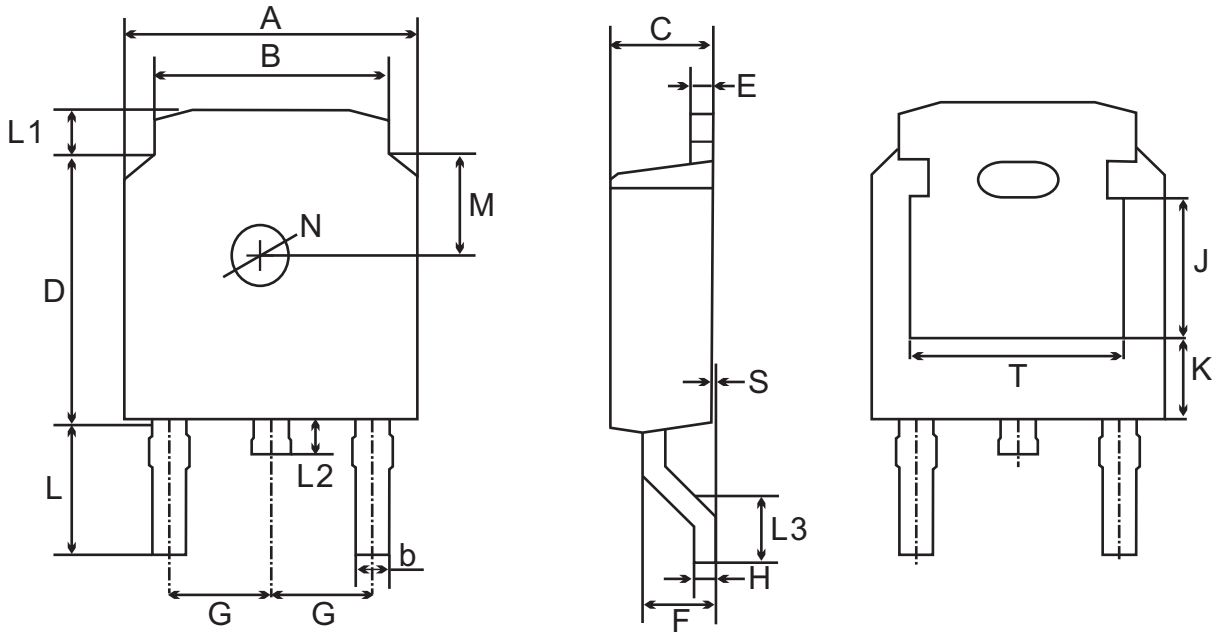
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TO-252(D-PAK) Package Outline Dimensions



TO-252(D-PAK) mechanical data

UNIT		A	B	b	C	D	E	F	G	H	L	L1	L2	L3	S	M	N	J	K	T
mm	max	6.7	5.5	0.8	2.5	6.3	0.6	1.8	2.29 TYPICAL	0.55	3.1	1.2	1.0	1.75	0.1	1.8 TYPICAL	1.3 TYPICAL	3.16	1.80	4.83
	min	6.3	5.1	0.3	2.1	5.9	0.4	1.3		0.45	2.7	0.8	0.6	1.40	0.0			ref.	ref.	ref.
mil	max	264	217	31	98	248	24	71	90 TYPICAL	22	122	47	39	69	4	71 TYPICAL	51 TYPICAL	124	71	190
	min	248	201	12	83	232	16	51		18	106	31	24	55	0			ref.	ref.	ref.

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